



200GE to 4X56G QSFP56 Direct Attach Cable FWH4D-200xxxxC

Features

- 1 QSFP56 and 4X SFP56 breakout form factor
- 26~30AWG support up to 3m length max
- Maximum aggregate data rate: 200Gb/s
- I2C interface for EEPROM signature which can be customized and

CMIS V4.0 compliant

- Operating Temperature: 0~ 70 °C
- ROHS Compliant

Applications

- 40GE/100GE/200GE
- Infiniband QDR/FDR/EDR/HDR
- Data storage and communication industry
- Switch / router / HBA
- Enterprise network
- Data Center Network

STANDARDS COMPLIANCE

- IEEE 802.3bj&IEEE802.3cd
- 100GEBASE-CR4&200GBASE-CR4
- InfiniBand architecture

Product Description

FIBERSTAMP's FWH4D-200xxxxxC cable assembly is high performance, cost effective I/O solutions for LAN, HPC and SAN. The passive cable assembly connects data signals from each of the 8 pairs on the single QSFP56 end to the 4 SFP56 multiport ends.

The high speed cable assembly meets and exceeds 200 Gigabit Ethernet, InfiniBand EDR /HDR and temperature requirements for performance and reliability.



Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit
Storage Ambient Temperature		-40		+85	°C
Operating Case Temperature	Тс	0		+70	°C
Power Supply Voltage	V _{CC3}	3.14	3.3	3.47	V
Data Rate Per Lane		1		28	GBaud/s







Differential Impedance

Parameter	Symbol	Min	Typical	Max	Unit
Differential Impedance(bulk cable)	Rin1,P-P	95	100	110	Ω
Differential Impedance (Mated connector)	Rin2,P-P	90	100	110	Ω
Differential Impedance(cable termination)	Rin3,P-P	85	100	110	Ω

PCB Contact Configuration

38	GND		GND	1
37	TX1n		TX2n	2
36	TX1p		TX2p	2
35	GND		GND	2
34	TX3n			4
33	TX3p		TX4n	2
32	GND		TX4p	0
31	LPMode	Card	GND	2 3 4 5 6 7 8 9
30	Vcc1	Ω	ModSelL	0
29	VccTx	đ	ResetL	
28	IntL	m	VccRx	10
27	ModPrsL	Edge	SCL	11
26	GND	Q	SDA	12
25	RX4p	Ŵ	GND	13
24	RX4n		RX3p	14
23	GND		RX3n	15
22	RX2p		GND	16
21	RX2n		RX1p	17
20	GND		RX1n	18
77.7%			GND	19

ELECTRICAL

Item	Specification
Low Level Contact Resistance	Initial: Baseline, with 75mm cable from the backshell edge.
	Change : 20 milliohms maximum
Insulation Resistance (Raw cable)	100VDC, 1000Mohm (Min.)
Dielectric Withstanding Voltage	AC 300V 1 min, no breakdown or flash

SIGNAL INTEGRITY

Α	Time domain parameter	Test condition	SPEC		Equipment
1	Differential Impedance(bulk		100+10/-50hms		
	cable)		100+107-3011115		
2	Differential Impedance		100+10/-10ohms		
	(Mated connector)		100+10/-100nms		
	Differential	TDR Tr:25ps			E5071C or
3	Impedance(cable		100+10/-15ohms		DSA8300
	termination)				
4	Intra-skew		L*15+20	L:length(m)	
4			SPEC:ps		
					-0-0

FIBERSTAMP

В	Frequency domain parameter	Test condition	Test spec(dB)	f(GHz)	
		Freq:50MHz	-22+20/25.78*f*10^(-3)	0.05≤f<4.1	
1	SDD11/SD D22	~20GHz Points:1601	-10.66+14*log((f*10^(-3))/5.5) ≤5.3dB@13.26GHz	4.1≤f≤19	
2	SCC11/SC C22	Freq:50MHz ~20GHz Points:1601	≤-2dB	0.2≤f≤19	
3	SDC11/SD C22	Freq:50MHz ~20GHz Points:1601	-16+2*f/3	0.05≤f≤2	
4	SCD21-SDD21	Freq:50MHz ~20GHz Points:1601	10 as 0.01≤f < 12.89 -27+29/22*f*0.001 a s 12.89≤f < 15.7 6.3 as 15.7≤f≤19	0.01≤f≤19	
5	MDNEXT	Freq:50MHz ~20GHz Points:1601	≤-26dB@12.89GHz	0.01≤f≤19	E5071C
6	SDD21	Freq:50MHz ~20GHz Points:1601 IF: 1KHz	-0.7*(f*10^(-3))^0.5-0.3*(f*10 ^(-3))- 0.01*(f*10^(-3))^2 <17.16dB@13.26GHz	0.01≤f≤19	
7	СОМ	IEEE802.3cd	>3dB		

MNICAL

Item	Specification	
Mating Force	40N Max. With retention latch disengaged.	
Un-mating Force	30N Max. With retention latch disengaged.	
Latch retention force	90N Min.	

Durability	250 cycles

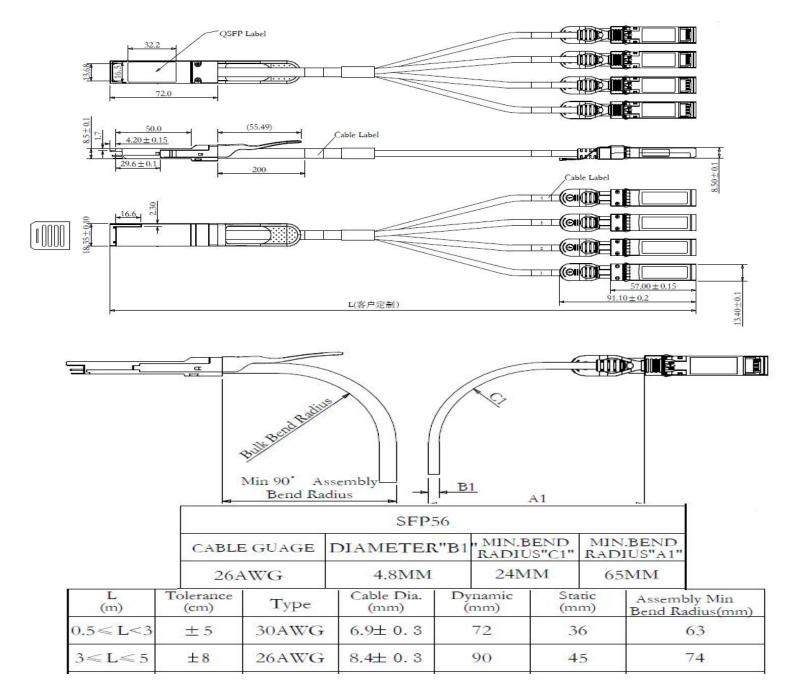


Data Sheet





Mechanical Dimensions



Wiring connection diagram

200G QSFP56 to 4X SFP56 QSFP A: RX1 SFP56 C: TX SFP56 B: TX QSFP A: RX2 1# 2# TX1 SFP56 B: RX TX2 SFP56 C: RX SFP56 D: TX QSFP A: RX3 QSFP A: RX4 SFP56 E: TX 4# 3# SFP56 E: RX SFP56 D: RX тхз TX4 1# B RX2 HHHHH RX4 TX3 2# C TOP









ENVIRONMENTAL

Item	Specification
	Subject mated specimens to 30G's half-sine shock pulses of 11 milliseconds
Physical shock	duration. 3 shocks in each direction applied along 3 mutually perpendicular
	planes, 18 total shocks
Vibratian (random)	Subject mated specimens to 3.10G's rms between 20-500
Vibration (random)	Hz for 15 minutes in each of 3 mutually perpendicular planes
Thermalsheek	100 cycles of:
Thermal shock	a) -55°C for 30 minutes b) +85°C for 30 minutes
Temperature Life	Subject mated Specimens to +105°C for 500 hours
Humidity and Temperature	Subject unmated specimens to 10 cycles (10 days)
cycling	between 25 and 65°C at 80% to 100% RH
Visual Examination.	Connectors & contacts shall have no evidence of physical defects or
	otherwise unfit for testing.

Regulatory Compliance

FIBERSTAMP GQS-4Q56-PXXC passive cable assembly meets the requirements of the following standards:

Feature	Standard
	EN 62368-1: 2014
Electrical Safety	IEC 62368-1:2014
	UL 62368-1:2014
Environmental protection	Directive 2011/65/EU with amendment(EU)2015/863
	EN55032: 2015
CE EMC	EN55035: 2017
	EN61000-3-2:2014
	EN61000-3-3:2013
FCC	FCC Part 15, Subpart B; ANSI C63.4-2014

Ordering information

Part Number			
Length (meter)	1	2	3
Wire gauge (AWG)	30	30	26

Important Notice

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